

# MURS120T3 Series

Preferred Devices

## Surface Mount Ultrafast Power Rectifiers

MURS105T3, MURS110T3, MURS115T3,  
MURS120T3, MURS140T3, MURS160T3

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

### Features

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.71 to 1.05 V Max @ 1.0 A,  $T_J = 150^{\circ}\text{C}$ )
- Pb-Free Packages are Available

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 95 mg (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes:  $260^{\circ}\text{C}$  Max. for 10 Seconds
- Polarity: Polarity Band Indicates Cathode Lead



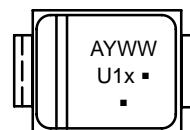
ON Semiconductor®

## ULTRAFAST RECTIFIERS 1.0 AMPERE, 50–600 VOLTS



SMB  
CASE 403A

### MARKING DIAGRAM



A = Assembly Location  
Y = Year  
WW = Work Week  
U1 = Device Code  
x = A, B, C, D, G, or J  
▪ = Pb-Free Package

(Note: Microdot may be in either location)

### ORDERING INFORMATION

See detailed ordering and shipping information in the table on page 2 of this data sheet.

### DEVICE MARKING INFORMATION

See general marking information in the device marking table on page 2 of this data sheet.

**Preferred** devices are recommended choices for future use and best overall value.

# MURS120T3 Series

## MAXIMUM RATINGS

Rating	Symbol	MURS						Unit
		105T3	110T3	115T3	120T3	140T3	160T3	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_R$	50	100	150	200	400	600	V
Average Rectified Forward Current	$I_{F(AV)}$	1.0 @ $T_L = 155^\circ\text{C}$ 2.0 @ $T_L = 145^\circ\text{C}$			1.0 @ $T_L = 150^\circ\text{C}$ 2.0 @ $T_L = 125^\circ\text{C}$			A
Non-Repetitive Peak Surge Current, (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	$I_{FSM}$	40			35			A
Operating Junction Temperature	$T_J$	- 65 to +175						$^\circ\text{C}$

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

## THERMAL CHARACTERISTICS

Rating	Symbol	MURS						Unit
		105T3	110T3	115T3	120T3	140T3	160T3	
Thermal Resistance, Junction-to-Lead ( $T_L = 25^\circ\text{C}$ )	$R_{\theta JL}$	13						$^\circ\text{C}/\text{W}$

## ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 1) ( $i_F = 1.0\text{ A}$ , $T_J = 25^\circ\text{C}$ ) ( $i_F = 1.0\text{ A}$ , $T_J = 150^\circ\text{C}$ )	$V_F$	0.875 0.71			1.25 1.05		V
Maximum Instantaneous Reverse Current (Note 1) (Rated DC Voltage, $T_J = 25^\circ\text{C}$ ) (Rated DC Voltage, $T_J = 150^\circ\text{C}$ )	$i_R$	2.0 50			5.0 150		$\mu\text{A}$
Maximum Reverse Recovery Time ( $i_F = 1.0\text{ A}$ , $di/dt = 50\text{ A}/\mu\text{s}$ ) ( $i_F = 0.5\text{ A}$ , $i_R = 1.0\text{ A}$ , $I_R$ to 0.25 A)	$t_{rr}$	35 25			75 50		ns
Maximum Forward Recovery Time ( $i_F = 1.0\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ , Rec. to 1.0 V)	$t_{fr}$	25			50		ns

1. Pulse Test: Pulse Width = 300  $\mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

## DEVICE MARKING AND ORDERING INFORMATION

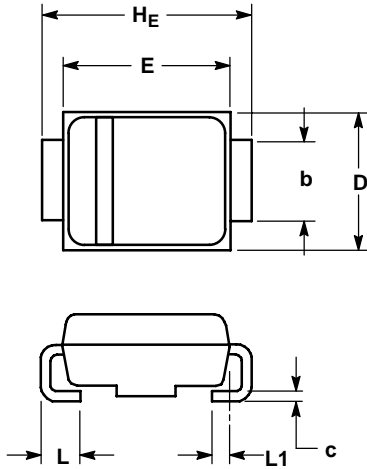
Device	Marking	Package	Shipping†
MURS105T3	U1A	SMB	2500 Units / Tape & Reel
MURS105T3G		SMB (Pb-Free)	
MURS110T3	U1B	SMB	
MURS110T3G		SMB (Pb-Free)	
MURS115T3	U1C	SMB	
MURS115T3G		SMB (Pb-Free)	
MURS120T3	U1D	SMB	
MURS120T3G		SMB (Pb-Free)	
MURS140T3	U1G	SMB	
MURS140T3G		SMB (Pb-Free)	
MURS160T3	U1J	SMB	
MURS160T3G		SMB (Pb-Free)	

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# MURS120T3 Series

## PACKAGE DIMENSIONS

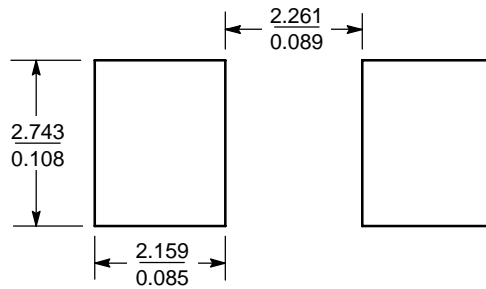
**SMB**  
CASE 403A-03  
ISSUE F



- NOTES:  
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.  
2. CONTROLLING DIMENSION: INCH.  
3. D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	1.90	2.13	2.45	0.075	0.084	0.096
A1	0.05	0.10	0.20	0.002	0.004	0.008
b	1.96	2.03	2.20	0.077	0.080	0.087
c	0.15	0.23	0.31	0.006	0.009	0.012
D	3.30	3.56	3.95	0.130	0.140	0.156
E	4.06	4.32	4.60	0.160	0.170	0.181
HE	5.21	5.44	5.60	0.205	0.214	0.220
L	0.76	1.02	1.60	0.030	0.040	0.063
L1	0.51 REF			0.020 REF		

### SOLDERING FOOTPRINT\*



SCALE 8:1  $\left(\frac{\text{mm}}{\text{inches}}\right)$

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.